XGA 3CCD color camera (1024 x 768) 1 Top View Camera 4 Angled View Cameras XGA mono camera (1024 x 768) Multi-segment, multi-angle LED, RGB+W Lighting

Optical Resolution 10, 15, 20, 25μm

Imaging Method High-speed dynamic imaging

OPTICAL AND IMAGING SYSTEM

IMAGING/INSPECTION SPEED

110 cm²/sec 25µm 72 cm²/sec 20µm 15µm 40 cm²/sec 18 cm²/sec 10µm

PRE-/POST-REFLOW INSPECTION

Component Defects Missing, tombstone, billboard, polarity and shift Solder Joint Defects Insufficient/excess solder and bridge

X-Y TABLE AND CONTROL

High Precision Ball Screw/Servo Motor with DSP-based motion controller

X,Y Axis Resolution

PCB AND DIMENSION

Max. PCB Size TR7500 510 x 460mm TR7500L 660 x 610mm

Max. PCB Thickness 4mm

Motor driven/clamping PCB Carrier/Fixing Clearance Top 50mm Bottom Edge 3.5mm Weight TR7500 850kg TR7500L 985kg

TR7500 (W) 1220mm x (D) 1480mm x (H) 2085mm Dimensions

> TR7500L (W) 1370mm x (D) 1570mm x (H) 2111mm

Power Supply 200-240V Single phase, 50/60Hz 3KVA

Optional Solutions OCR, OCV, coaxial lighting, barcode system, off-line editor, repair station,

SPC software and yield management system (YMS)

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C-7500-EN-1301



- ULTRA-HIGH-SPEED IN-LINE AOI SYSTEM
- TOP-VIEW DIGITAL 3CCD FULL COLOR CAMERA + 4 ANGLED CAMERAS FOR THE MOST COMPLETE AOI COVERAGE
- RGB+W MULT
 I-ANGLE LIGHTING CONTROL
- 01005 COMPONENT/12 MIL FINE-PITCH READY
- DESIGNED FOR LEAD-FREE AND LEGACY PCB ASSEMBLIES
- PRE-/POST-REFLOW COLOR AOI OPTIMAL SOLUTION



TR7500



FEATURES TR7500

A NEW AOI SYSTEM FOR A NEW GENERATION OF SMT



BEST THROUGHPUT FOR INLINE PRODUCTION

Dynamic imaging technology provides vibration-free imaging of a PCB with high throughput. Inspection speed can be reduced to as little as 14 seconds for a medium-sized board (@25µm, excluding locating fiducial marks and loading time). It is also safe for pre-reflow inspection.

HIGH RESOLUTION IMAGING SYSTEM

The new 3CCD multiple color and monochrome camera system (top and angled views) and range optical resolutions (10, 15, 20, and 25µm) enable the TR7500 to capture up to 250 frames/ sec of standard XGA format images (1024 x 768 pixels). Four angled cameras provide high accuracy for solder joint and lifted lead inspection. With an ultra-high resolution of 10µm, small components such as 01005 chips can be easily inspected.

MODULARIZED CONTROL SYSTEM

The precision X-Y table, conveyor system, image acquisition, lighting system and the host PC are all independent modules to allow for easy diagnostics and system maintenance.

ADVANCED COLOR LIGHTING

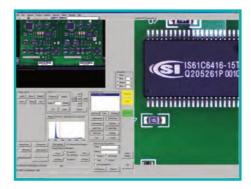
The new RGB+W lighting control and the color imaging system instantly provide operators with easier visual verification of real images. The advanced color lighting system significantly improves 3D solder fillet reconstruction, providing more accurate inspection results for solder fillet on small components such as 01005 and fine pitch leads.

EASY PROGRAMMING ENVIRONMENT

- Programming is easily accomplished by using the data from a CAD file directly. The only mandatory data fields are component name, package type, X-position, Y-position, and rotation angle.
- · PCBs with special layouts also can be easily edited.
- TRI provides a standard model library for most of the main component types and they are presented graphically for ease of use. This can greatly reduce the time spent creating inspection boxes and setting parameters.
- Accurate warp compensation and a multi-fiducial finding algorithm ensure the correct positioning of the inspection windows, leading to accurate, repeatable defect detection.



Built-in Model Library Function







Color board view for better image clarity

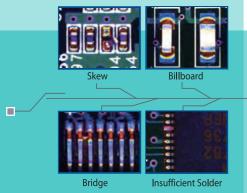
Graphical lighting control editor

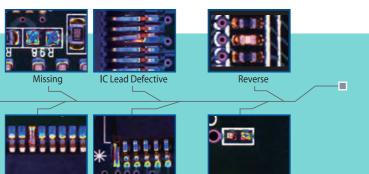
YIELD MANAGEMENT SYSTEM*

- · Testers enable process capability control
- Real time defect information integration and analysis
- Defect knowledge management

* Optional



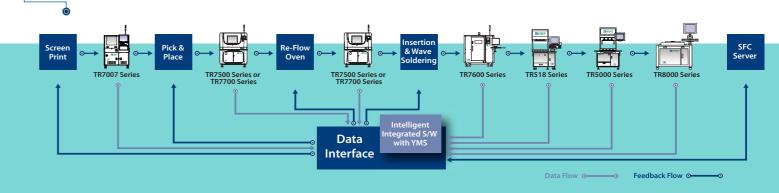




Lifted Lead



Angle View (mono)



Open